

Surface-Mount TMBS[®] (Trench MOS Barrier Schottky) Rectifier

eSMP[®] Series



Top view

Bottom view

SMF (DO-219AB)

Cathode Anode

FEATURES

- Trench MOS Schottky technology
- Low profile package
- Ideal for automated placement
- Low forward voltage drop, low power losses
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Wave and reflow solderable
- AEC-Q101 qualified available
 - Automotive ordering code: base P/NHM3
- Compatible to SOD-123W package case outline
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

 AUTOMOTIVE
GRADE
Available

RoHS
COMPLIANT
HALOGEN
FREE

LINKS TO ADDITIONAL RESOURCES



3D Models

PRIMARY CHARACTERISTICS

| | |
|--|----------------|
| $I_{F(AV)}$ | 2.0 A |
| V_{RRM} | 200 V |
| I_{FSM} | 60 A |
| V_F at $I_F = 2$ A ($T_A = 125$ °C) | 0.64 V |
| T_J max. | 175 °C |
| Package | SMF (DO-219AB) |
| Circuit configuration | Single |

TYPICAL APPLICATIONS

For use in high frequency inverters, freewheeling, DC/DC converters, and polarity protection in commercial, industrial, and automotive applications.

MECHANICAL DATA

Case: SMF (DO-219AB)

Molding compound meets UL 94 V-0 flammability rating
 Base P/N-M3 - halogen-free, RoHS-compliant
 Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 and HM3 suffix meet JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

MAXIMUM RATINGS ($T_A = 25$ °C unless otherwise noted)

| PARAMETER | SYMBOL | V2F22 | UNIT |
|--|----------------------------|-------------|------|
| Device marking code | | V2D | |
| Maximum repetitive peak reverse voltage | V_{RRM} | 200 | V |
| Maximum DC reverse voltage | V_{DC} | 160 | V |
| Maximum average forward rectified current (fig.1) | $I_{F(AV)}$ ⁽¹⁾ | 2.0 | A |
| Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load | I_{FSM} | 60 | A |
| Operating junction temperature range | T_J ⁽²⁾ | -40 to +175 | °C |
| Storage temperature range | T_{STG} | -55 to +175 | |

Notes

⁽¹⁾ Free air, mounted on recommended copper pad area

⁽²⁾ The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$



| ELECTRICAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted) | | | | | | |
|---|----------------------|-----------------------------------|-------------|------|------|---------------|
| PARAMETER | TEST CONDITIONS | | SYMBOL | TYP. | MAX. | UNIT |
| Instantaneous forward voltage | $I_F = 1.0\text{ A}$ | $T_A = 25\text{ }^\circ\text{C}$ | $V_F^{(1)}$ | 0.72 | - | V |
| | $I_F = 2.0\text{ A}$ | | | 0.79 | 0.87 | |
| | $I_F = 1.0\text{ A}$ | $T_A = 125\text{ }^\circ\text{C}$ | | 0.56 | - | |
| | $I_F = 2.0\text{ A}$ | | | 0.64 | 0.72 | |
| Reverse current | $V_R = 160\text{ V}$ | $T_A = 25\text{ }^\circ\text{C}$ | $I_R^{(2)}$ | 0.3 | - | μA |
| | | $T_A = 125\text{ }^\circ\text{C}$ | | 300 | - | |
| | $V_R = 200\text{ V}$ | $T_A = 25\text{ }^\circ\text{C}$ | | - | 60 | |
| | | $T_A = 125\text{ }^\circ\text{C}$ | | 700 | 3500 | |
| Typical junction capacitance | 4.0 V, 1 MHz | | C_J | 160 | - | pF |

Notes

- (1) Pulse test: 300 μs pulse width, 1 % duty cycle
(2) Pulse test: Pulse width $\leq 5\text{ ms}$

| THERMAL CHARACTERISTICS ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted) | | | |
|--|--------------------------|-------|--------------------|
| PARAMETER | SYMBOL | V2F22 | UNIT |
| Typical thermal resistance | $R_{\theta JA}^{(1)(2)}$ | 125 | $^\circ\text{C/W}$ |
| | $R_{\theta JM}^{(3)}$ | 26 | |

Notes

- (1) The heat generated must be less than the thermal conductivity from junction-to-ambient: $dP_D/dT_J < 1/R_{\theta JA}$
(2) Free air, mounted on recommended copper pad area; thermal resistance $R_{\theta JA}$ - junction to ambient
(3) Mounted on recommended copper pad area; thermal resistance $R_{\theta JM}$ - junction to mount

| ORDERING INFORMATION (Example) | | | | |
|--------------------------------|-----------------|------------------------|---------------|------------------------------------|
| PREFERRED P/N | UNIT WEIGHT (g) | PREFERRED PACKAGE CODE | BASE QUANTITY | DELIVERY MODE |
| V2F22-M3/H | 0.015 | H | 3000 | 7" diameter plastic tape and reel |
| V2F22-M3/I | 0.015 | I | 10 000 | 13" diameter plastic tape and reel |
| V2F22HM3/H ⁽¹⁾ | 0.015 | H | 3000 | 7" diameter plastic tape and reel |
| V2F22HM3/I ⁽¹⁾ | 0.015 | I | 10 000 | 13" diameter plastic tape and reel |

Note

- (1) AEC-Q101 qualified

RATINGS AND CHARACTERISTICS CURVES ($T_A = 25\text{ }^\circ\text{C}$ unless otherwise noted)

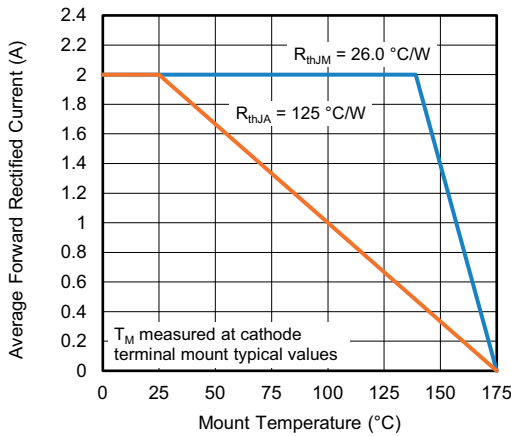


Fig. 1 - Maximum Forward Current Derating Curve

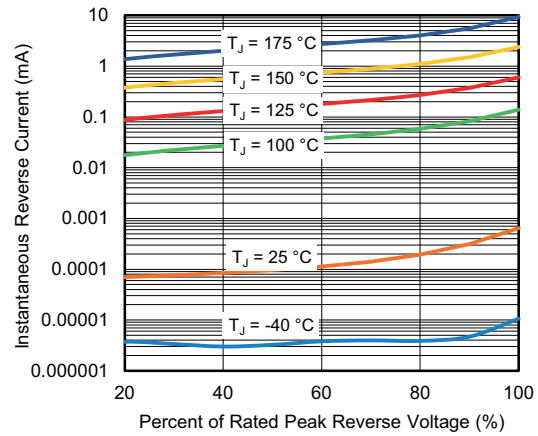


Fig. 4 - Typical Reverse Leakage Characteristics

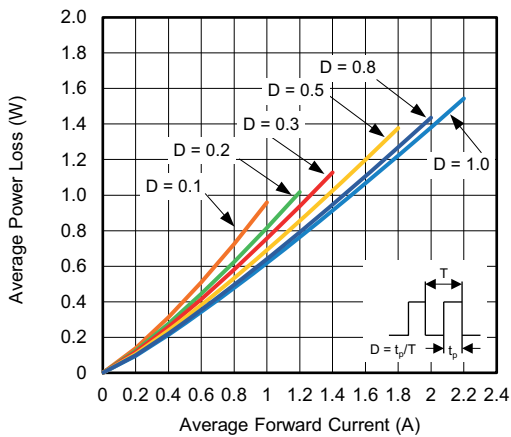


Fig. 2 - Average Power Loss Characteristics

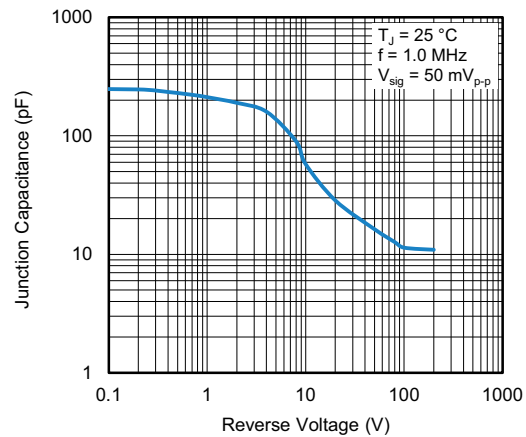


Fig. 5 - Typical Junction Capacitance

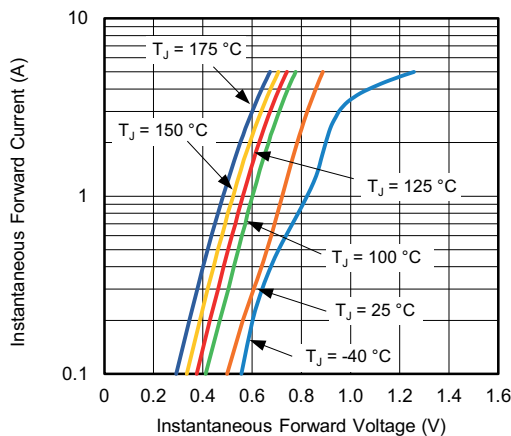


Fig. 3 - Typical Instantaneous Forward Characteristics

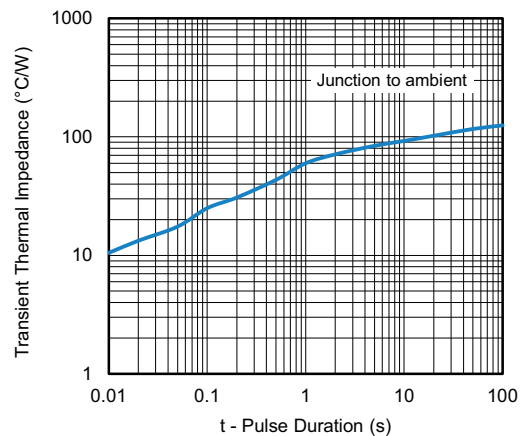
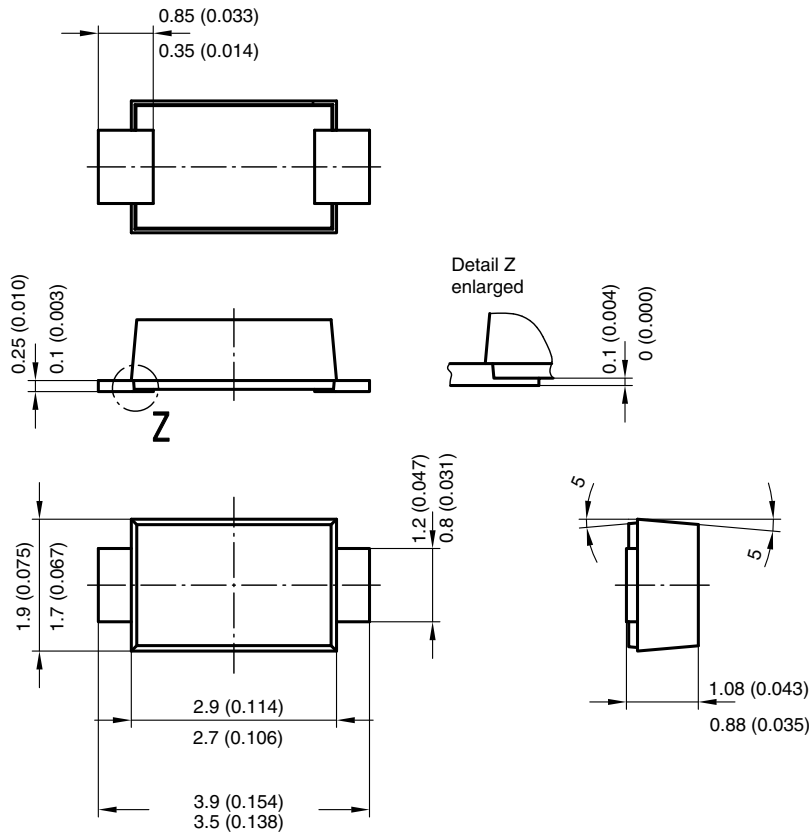
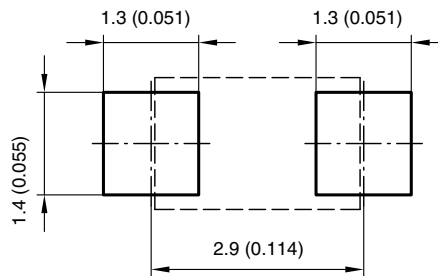


Fig. 6 - Typical Transient Thermal Impedance

PACKAGE OUTLINE DIMENSIONS in millimeters (inches)



Foot print recommendation:



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 17247



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